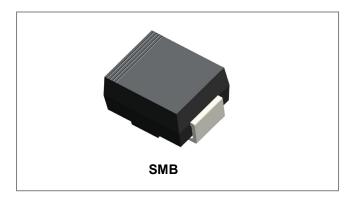


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# RoHS HF

#### SD560B STANDARD RECTIFIER



# **Circuit Diagram**



#### **Features**

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Low Power Loss
- Built Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-O
- This is a Halogen Free Device
- . All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

#### **Mechanical Data**

- Case: SMB molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.09 grams

## Maximum Ratings and Electrical Characteristics @T<sub>A</sub>=25°C unless otherwise specified

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Characteristic	Symbol	SD560B	Units
Maximum Peak Repetitive Reverse Voltage Maximum DC Blocking Voltage	V <sub>RRM</sub> V <sub>DC</sub>	600	V
Maximum RMS Voltage	V <sub>RMS</sub>	420	V
Maximum Average Forward Rectified Current in DC @Tc = 75°C	I <sub>(AV)</sub>	5.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	200	А
I <sup>2</sup> t Rating for fusing (t < 8.3ms)	I² t	166	A <sup>2</sup> S
Maximum Instantaneous Forward Voltage* @I <sub>F</sub> = 5.0A	V <sub>F</sub>	1.2	V
Maximum DC Reverse Current*	I <sub>R</sub>	9.0 170	uA
Typical Junction Capacitance (Note 1)	Cj	32	pF
Typical Thermal Resistance Junction to Case (Note 2)	R <sub>0</sub> JC	7	°C/W
Typical Thermal Resistance Junction to Lead (Note 2)	$R_{ heta JL}$	3.6	°C/W
Typical Thermal Resistance Junction to Ambient (Note 2)	$R_{ heta JA}$	42	°C/W
Operating Storage Temperature Range	T <sub>STG</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +175	°C

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

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<sup>2.</sup> Thermal resistance from junction to ambient at 0.375"(9.5mm)lead length, P.C.B. mounted.



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## **Ratings and Characteristics Curves**

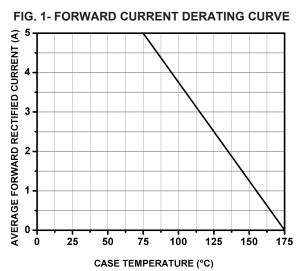


FIG. 3-TYPICAL INSTANTANEOUS FORWARD

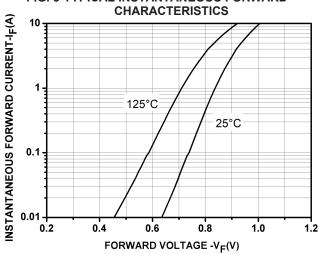


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD

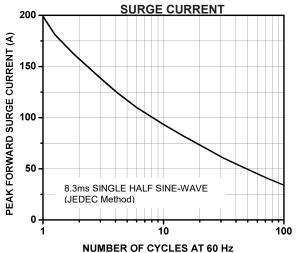
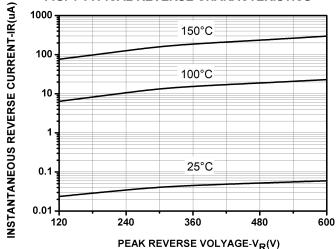
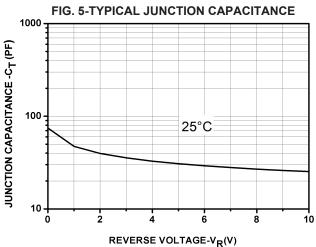


FIG. 4-TYPICAL REVERSE CHARACTERISTICS





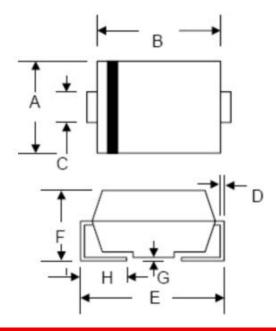
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## **Mechanical Dimensions SMB**



CVMPOL	Millimeters		Inches	
SYMBOL	Min.	Max.	Min.	Max.
А	3.30	3.94	0.130	0.155
В	4.06	4.70	0.160	0.185
С	1.80	2.20	0.071	0.087
D	0.152	0.305	0.006	0.012
Е	4.80	5.59	0.189	0.220
F	2.10	2.60	0.083	0.102
G	0.051	0.203	0.002	0.008
Н	0.76	1.52	0.030	0.060

# **Ordering Information**

Device	Package	Shipping
SD560B	SMB	3000pcs / reel
SD560BTR	SMB	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

# **Marking Diagram**



Where XXXXX is YYWWL

 SD560B
 = Part Name

 YY
 = Year

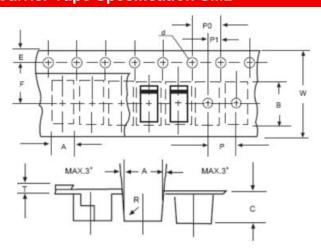
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

# **Carrier Tape Specification SMB**



SYMBOL	Millimeters		
STWIBOL	Min.	Max.	
Α	3.99	4.19	
В	5.72	5.92	
C	3.23	3.43	
d	1.40	1.60	
E	1.40	1.60	
F	5.60	5.70	
Р	7.90	8.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	-	0.60	
W	11.80	12.20	

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## **SD560B**



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